

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of Hall et al

Serial No. 09/811,101

Filed: March 16, 2001

Title: **MULTI-LAYERED HIGH DENSITY
CONNECTIONS**

Art Unit 2827

Examiner Dinh

Confirmation No. 8303

Atty. Docket No. END920000087US1 (IEN-10-5540)

AMENDMENT

FAX RECEIVED

Assistant Commissioner for Patents
Washington, D.C. 20231

NOV 06 2002

TECHNOLOGY CENTER 2800

Dear Sir:

This amendment is filed in response to the office action dated August 28, 2002.

Please amend the application in the following respects:

In the specification:

Please replace paragraph 2 on page 5 which continues as paragraph 1 on page 6 with the attached revised paragraph.

Please replace paragraph 3 on page 10 which continues as paragraph 1 on page 11 with the attached revised paragraph;

Please replace paragraph 3 on page 11 which continues as paragraph 1 on page 12 with the attached revised paragraph.

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PATENT

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